

SD CARD

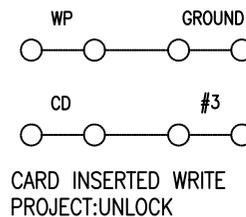
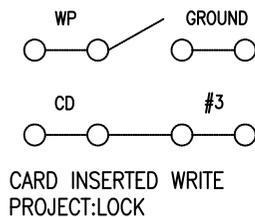
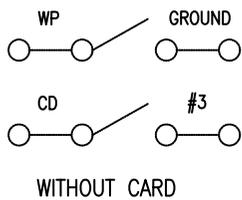
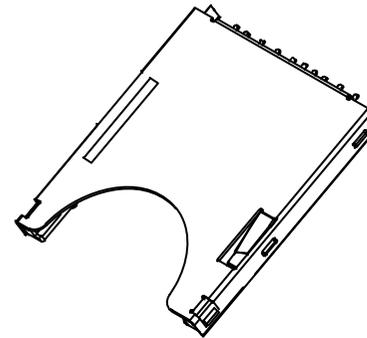
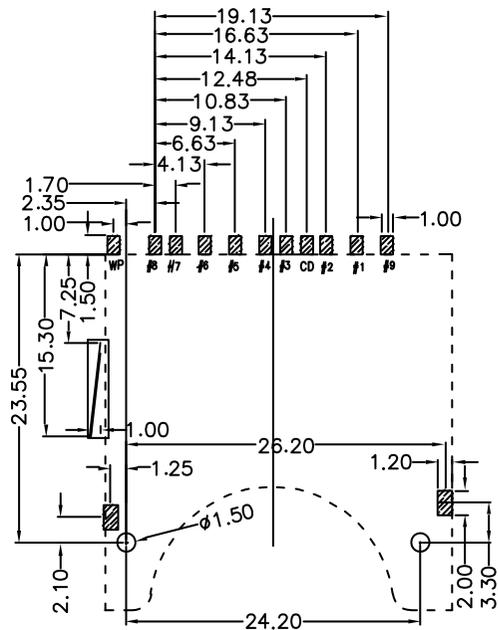
NOTES:

- 1.MATERIAL:
HOUSING: HIGH TEMPERATURE THERMOPLASTIC UL94V_0,COLOR:BLACK.
CONTACT: COPPER ALLOYS.
COVER: COPPER ALLOYS OR STEEL.
- 2.PLATING:
UNDERPLATE: NICKEL.
CONTACT AREA: GOLD OVER NICKEL.
SOLDER AREA: TIN OVER NICKEL.
- 3.MULTIMEDIA CARD COMPATIBLE



General	Angle	设计		
X \pm 0.50	X \pm 2°	DESIGN		
.X \pm 0.30	.X \pm 1°	校阅		
.XX \pm 0.20	.XX \pm 0.5°	CHECK		
GENERAL TOLERANCE UNLESS OTHERWISE NOTED		承认		
		APPRO.		

E		TITLE: 标准SD卡卡座	
PART NO.		BX-SD-2.9HY	
PRODUCT SPEC.		标准SD卡卡座	
FILE NAME.			
SCALE	1:1	UNIT:mm	A4
		SHEET:1 OF 3	

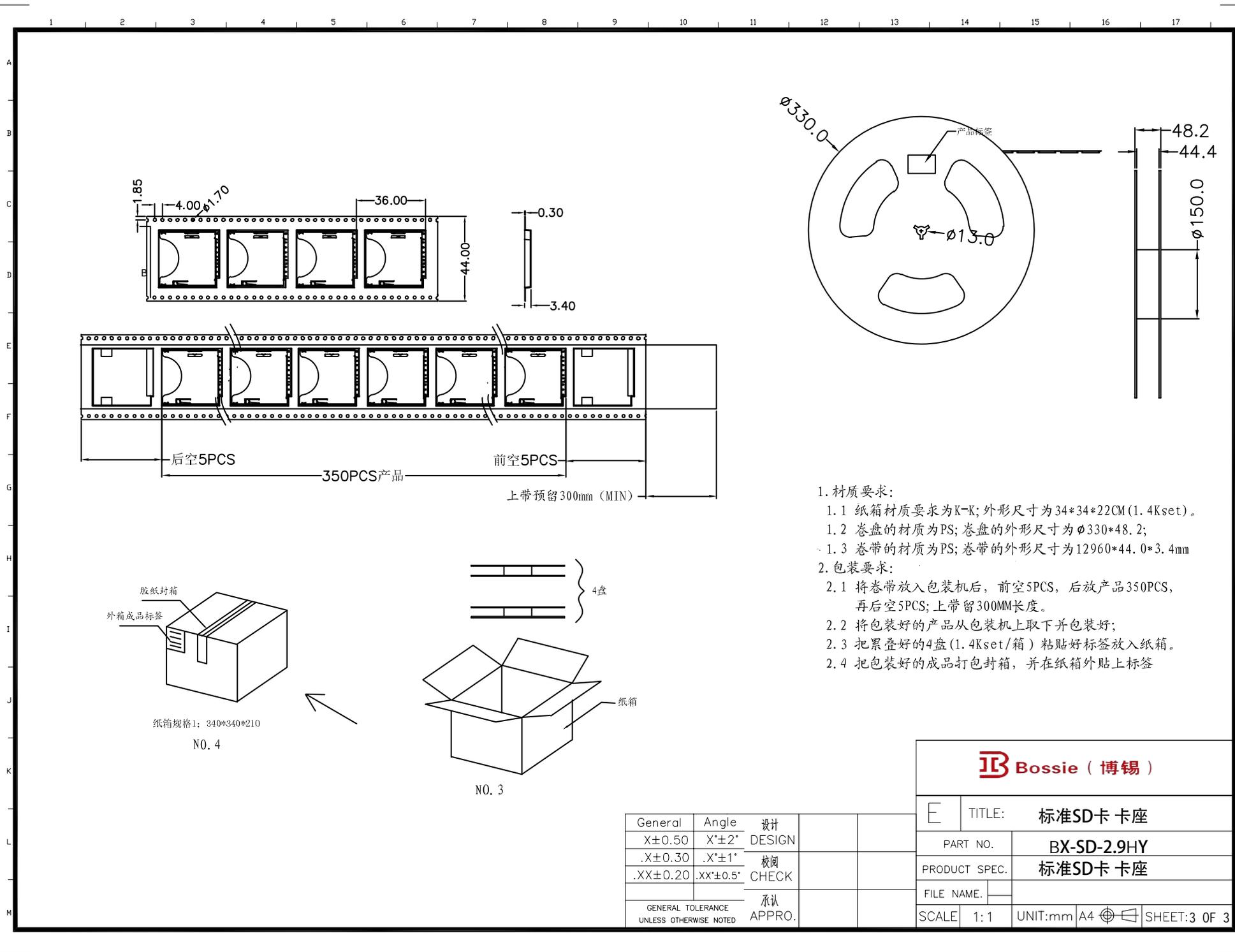


SD CARD PIN DESIGN

PIN NO.	NAME	TYPE	DESCRIPTION
#1	CD/DAT3	I/O/PP	CARD DETECT/DATA LINE(BIT3)
#2	CMD	PP	COMMAND/RESPONSE
#3	VSS1	S	SUPPLY VOLTAGE GROUND
#4	VDD	S	SUPPLY VOLTAGE
#5	CLK	I	CLOCK
#6	VSS2	S	SUPPLY VOLTAGE GROUND
#7	DAT0	I/O/PP	DATA LINE(BIT 0)
#8	DAT1	I/O/PP	DATA LINE(BIT 1)
#9	DAT2	I/O/PP	DATA LINE(BIT 2)

General	Angle	设计		
X±0.50	X*±2°	DESIGN		
.X±0.30	.X*±1°	校阅		
.XX±0.20	.XX*±0.5°	CHECK		
GENERAL TOLERANCE UNLESS OTHERWISE NOTED		承认		
		APPRO.		

IB Bossie (博锡)			
E	TITLE: 标准SD卡卡座		
PART NO.		BX-SD-2.9HY	
PRODUCT SPEC.		标准SD卡卡座	
FILE NAME.			
SCALE	1:1	UNIT:mm	A4 SHEET:2 OF 3



1. 材质要求:
- 1.1 纸箱材质要求为K-K; 外形尺寸为34*34*22CM (1.4Kset).
 - 1.2 卷盘的材质为PS; 卷盘的外形尺寸为 $\phi 330*48.2$;
 - 1.3 卷带的材质为PS; 卷带的外形尺寸为12960*44.0*3.4mm
2. 包装要求:
- 2.1 将卷带放入包装机后, 前空5PCS, 后放产品350PCS, 再后空5PCS; 上带预留300MM长度。
 - 2.2 将包装好的产品从包装机上取下并包装好;
 - 2.3 把累叠好的4盘 (1.4Kset/箱) 粘贴好标签放入纸箱。
 - 2.4 把包装好的成品打包封箱, 并在纸箱外贴上标签

JB Bossie (博锡)

E	TITLE:	标准SD卡卡座		
	PART NO.	BX-SD-2.9HY		
	PRODUCT SPEC.	标准SD卡卡座		
	FILE NAME.			
SCALE	1:1	UNIT:mm	A4	SHEET:3 OF 3

General	Angle	设计		
X \pm 0.50	X \pm 2°	DESIGN		
.X \pm 0.30	.X \pm 1°	校阅		
.XX \pm 0.20	.XX \pm 0.5°	CHECK		
GENERAL TOLERANCE UNLESS OTHERWISE NOTED		承认		
		APPRO.		